

L Number	Hits	Search Text	DB	Time stamp
1	205	(324/73.1).ccor.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 18:09
2	61	((324/73.1).ccor.) and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 15:44
3	17	((324/73.1).ccor.) and semiconductor) and pad	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 15:45
4	15	((324/73.1).ccor.) and (pad with input)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 17:07
5	1		USPAT	2003/08/10 16:48
6	1		USPAT	2003/08/10 16:49
7	1		USPAT	2003/08/10 16:49
8	1		USPAT	2003/08/10 16:59
9	1		USPAT	2003/08/10 17:01
10	1		USPAT	2003/08/10 17:01
11	1		USPAT	2003/08/10 17:02
12	1		USPAT	2003/08/10 17:02
13	1		USPAT	2003/08/10 17:04
14	13	((324/73.1).ccor.) and (pad with signal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 17:13
15	1		USPAT	2003/08/10 17:09
16	1		USPAT	2003/08/10 17:09
17	1		USPAT	2003/08/10 17:09
18	1		USPAT	2003/08/10 17:09
19	1		USPAT	2003/08/10 17:10
20	1		USPAT	2003/08/10 17:10
21	3729	(324/763-765).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 17:13
22	774	((324/763-765).ccls.) and (test\$4 with pad)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 17:16

23	2	((324/73.1).ccor.) and (((324/763-765).ccls.) and (test\$4 with pad))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 17:15
24	238	(((324/763-765).ccls.) and (test\$4 with pad)) and (input with pad)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 17:58
25	38	(((324/763-765).ccls.) and (test\$4 with pad)) and (input with pad)) and (electrical adj3 characteristic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 17:59
26	55218	((324/73.1).ccor.) (electrical adj4 characteristic)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 18:10
27	205	324/73.1.ccor.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 18:11
28	3	324/73.1.ccor. and (nmos and pmos)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 18:14
29	34	324/73.1.ccor. and (pad)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/10 18:14